

SP002 / SP002-R

MANUAL SCREEN-/STENCILPRINTER



Installation & User Manual

For: SP003 / SP003-V
Part-Nr.: SPMASP-SP003-E
Version: 1.1
Author:
Checked:
Release Date: 01.04.2007

You have opted for an ESSEMTEC Screen-/Stencilprinter. We thank you for this decision and congratulate to it.

Your machine has been produced to the highest standard and all functionality has been fully tested before delivery. The operation of this machine is very simple; still we strongly recommended that you read through this entire manual before operating any part of this machine. If you have any additional questions which are not answered in this manual, please contact us.

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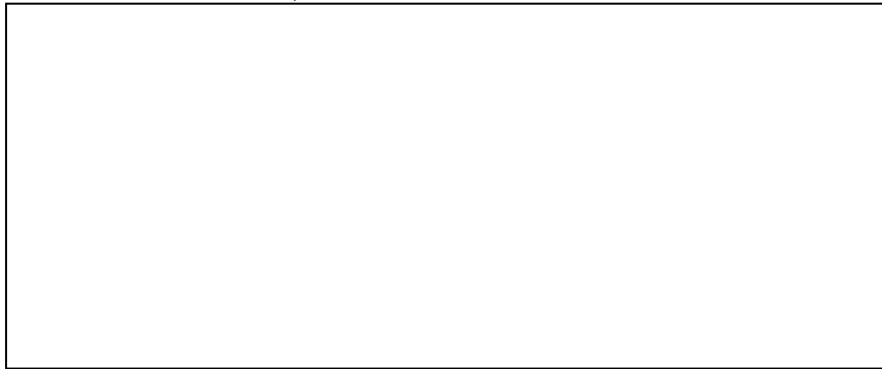
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www.essemtec.com

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1. Base specification all models

Baseplate for PCB's:	420 x 340mm
Max. size screen frames:	435 x 355mm (standard) 500 x 355mm (option: SP002-1)
Max. height of PCB:	40mm (standard)
Fixation of screen frames:	with screws into screen frame (4 x M6 or M8)
Needed tablespace:	680 x 600mm
Weight:	depending the model between 25 and 35 Kgs.
Opening upper frame:	with gas spring
Upgradeabilities:	all manual models can be upgraded at a later stage with the guided squeegee option (SP002-R)

2. Unpacking

Please check before unpacking the system if any transportation damage is visible on the outside of the packacking. If any damage is visible, please inform immediately your freight forwarder.

Your system is delivered according to your ordered specifications. Basically it consists of the following parts:

- Base system with standard accessories (toolset, on models with squeegee guidance: handle for guidance and double squeegee set)
- ordered Accessories (squeegees, registration frame, etc.)

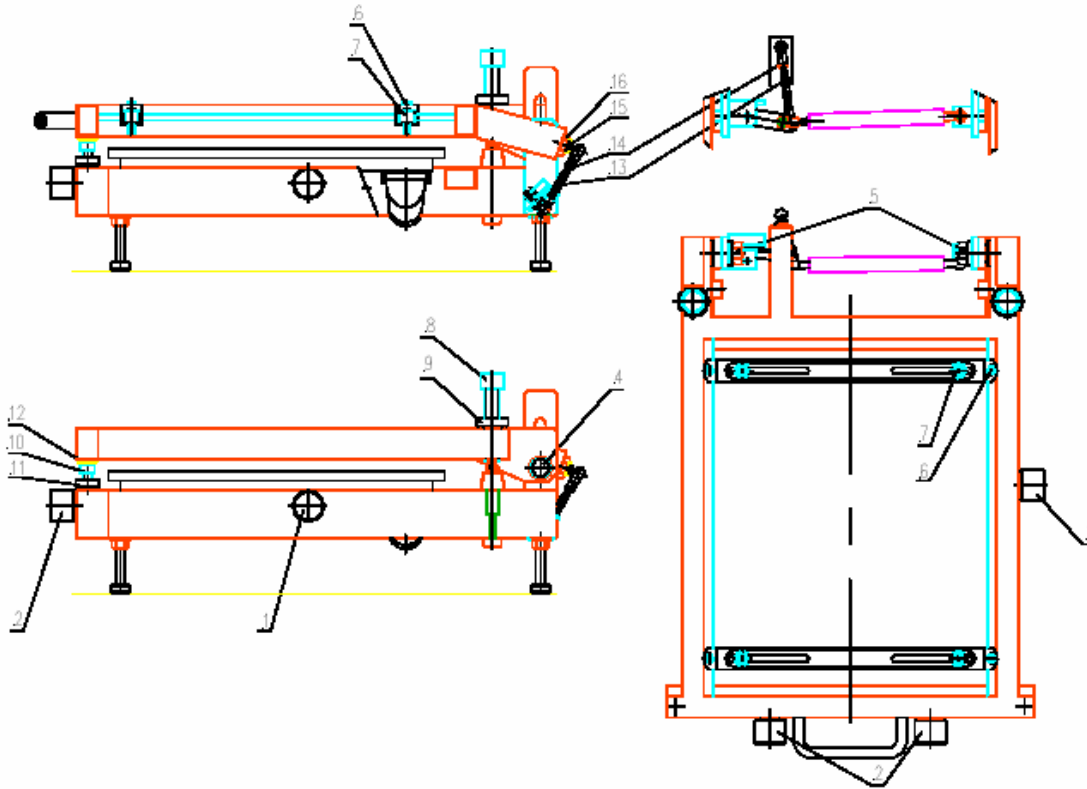
Please put the base unit onto a stable table.

The system was already adjusted in our factory. Nevertheless as there are many differences in weight in screen and stencilframes on the market, some readjustments may be necessary. Please follow the directions in the forthcoming chapters.

3. List of options

For the SP002 Printers a number of helpfull accessories are available.

4. Details



1. Adjustment PCB plate in x-direction
2. Adjustment PCB plate in y-direction (turning both knobs in the same direction) or adjustment of rotation (turning only one knob)
4. Joint of upper frame, is released when upper frame is lowered onto supports (8)
5. Height adjustment upper frame backside (rough alignment)
6. Adjustment of the screenframe holder bar
7. Adjustment of the screenframe holder screws (according to customer's screenframe, usually M6 or M8 screws)
8. Height adjustments upper frame backside (fine-adjustment)
9. Fixations of height adjustment screws
10. Height adjustments upper frame frontside (fine-adjustment)
11. Fixations of height adjustment screws
12. Adjustment bars for frontside height screws
- 13.-16. Gasspring construction for opening support upper frame

5. Adjustment possibilities

5.1. Height adjustment / On all models

The gap of the upper frame to the base plate, resp. from the PCB surface to the screen/stencil bottom side is an important parameter for proper printing results.

To adjust this distance, the following steps have to be made:

1. Lay the screenframe or the stencil tension frame into the printer and close the upper frame
2. Open the screws (5) with the in the delivery included tool
3. Loose all fixations of the height adjustment (9, 11)
4. Attach the screenframe or stencil tension frame on the rails (6, 7)
5. Adjust the height of all 4 hieght adjustment screws (8, 10) / see also advice in chapter 5.2) and fix the height with the fixation (9, 11)
 - Important: The balls of the frontside height adjustment screws (10) have to fit precisly into the bars (12) to ensure a high repetitivity during printing operation
6. Tighten the screws (5)
7. You may check by light tapping onto upper frame if the upper frame is laying on all 4 supports

5.1.1. Practical advice for height adjustment

Basically, in working with screens the difference between screen and PCB surface should be around 0,5 to 1,5mm. This in contrast to stencil printing where the stencil has to lay directly on the PCB.

To calculate the correct distance you can easliy so this according to the following formula:
 Length of the used squeegee in mm multiplied be 0.005

In practical work this difference may vary slightly due to different squeegee angles and pressures. Try it out to get the best printing results!

You may adjust the height even easier by using the optional available height wedge SP002-14.

5.2. Gas-Spring loaded opening of upper frame / On all models

The base adjustment was made already in our factory. Due to construction details, the height adjustment has no influence onto the gasspring, as the gas support is highered or lowered automatically at the same time.

When using heavy screen frames it might be possible that the gas loaded spring itself has to be readjusted. Please make the following steps to do so.

5.2.2. Adjusting of balancing mechanism:

Balancing mechanism has following items for adjustment:

- | | |
|----|---|
| 13 | Opening rod |
| 14 | locking nut M6 |
| 15 | arm setting screw |
| 16 | locking nut of arm setting screw M 16x1.5 |

Basic adjustment is made at manufacturer's plant.

Balancing force at closed frame can be increased by prolonging of opening rod 13



WARNING: A complete loosening of this rod may cause injury due to the air spring shock expanding

- Loose the locking nut 14
- By turning with the opening rod 13 adjust the required length (always check for the required opening force of the upper frame – frame must sit in closed position by its weight on all four points.
- Tighten the locking nut 14

The increase of the opening force during opening and thus the final balancing force by open frame can be adjusted by prolonging of the arm by arm setting screw 15.



WARNING: A complete loosening of this rod may cause injury due to the air spring shock expanding

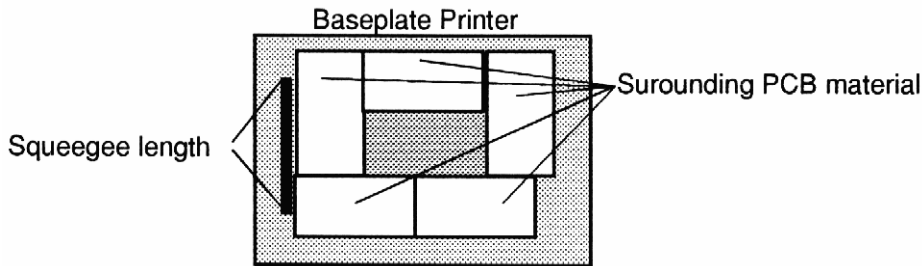
- Loose the locking nut 16
- turn the arm setting screw into required position (do it by the opened upper frame and always check the balancing force to be enough to hold upper frame open)
- Tighten the locking nut 14

6. PCB Fixation

6.1. All models

PCB's are placed on the base plate of the SP002 so the pads are almost in accordance with holes of the screens/stencils. Depending on the base plate type (B,V or G) we strongly recommend that the surrounding areas are also covered with empty PCB's or PCB material of the same thickness. This is preventing during printing the damage of the screens or stencils at the edges of the PCB and ensures a long life of your screens/stencils.

Example:



6.2. Fixation on model B / Flat Base Plate

The easiest way is to fix the surrounding PCB material with double-sided adhesive tape. In this way you establish a kind of mask where you can simply lay into the PCB which has to be printed.

6.3. Fixation on model V / Vacuum table

Same procedure as on model B. Use also surrounding PCB's for preventing damages on screens and stencils. Additionally the same material is used to cover the vacuum holes.

The vacuum plate is usually used for bended or flexible, thin PCB's as they are held properly into position due to vacuum suction.

The connection for the vacuum is below the printer. Optional available is an external vacuum pump.

6.4. Fixation of PCB on model G / Groove table

Within the groove slideable plates with fixing pins almost every position of a PCB can be defined by using the pinholes of a PCB. Therefore no adhesive tapes are necessary on this model. Nevertheless also here it is recommended to use surrounding PCB material to prevent damages on your screen or stencils.



WARNING: Please make sure that the pins are NOT higher than the PCB. Damages on screen/stencil may occur if they do so.

7. Adjusting the PCB

7.1. With base models

After inserting the PCB into the printer (according to chapter 6), slightly press the screen onto the PCB and check if the pads of the PCB are fitting the holes of the screen. With the adjustment screws for x/y and rotation axis (1,2) the fine adjustment can be made.

Using stencils it is not necessary to press down as it already lays on the PCB surface.

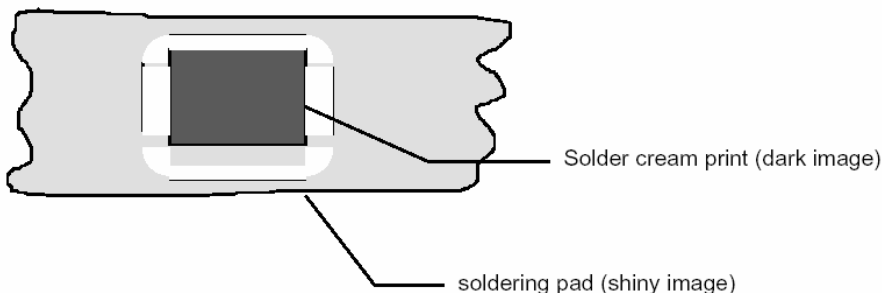
7.2. With option SP002-3 registration frame

Printing critical pads (i.e. Pine-Pitch) resp. for arranging the printer much faster, the option SP002-3 registration frame (also know as test printing frame) was developed.

Application:

- attach the PCB to the foreseen position on the base plate
- put the registration frame with the 4 bins into the previewed holes
- close the upperframe of the printer
- print directly, without readjusting the x/y-axis onto the registration frame
- open printer and you see now the actual done printing on the special, acidresistant foil of the registration frame
- now you may readjust the printer in x/y- and rotation axis in a very precise manner with the actual printed solder cream
- take away the registration frame and you may clean it
- now you may start immediately with printing

The 4 height supports of the upper frame ensure the high repetability and ensures now a printing cycle without any readjustments.



8. Applying solder cream

Apply a sufficient amount of solder cream about 5-10cm behind the first openings of the PCB onto the screen or stencil

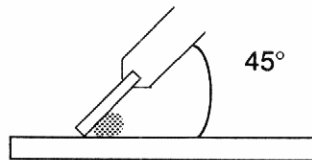
Makesure you apply a sufficient amount over the complete lenght of the squeegee, resp. printing width.

(See also hints and tips within chapter 10)

9. Printing

9.1. Squeegee angle

With the manual SP002 devices manual squeegees with 75 shore squeegee hardness are delivered, which ensure an ideal manual printing. To achieve a proper printing it is recommended to hold the squeegee in an angle of 45°.



On models with the guided squeegee as there is more pressure applied due to the mechanics.

Hardness of the squeegees are 85 Shore

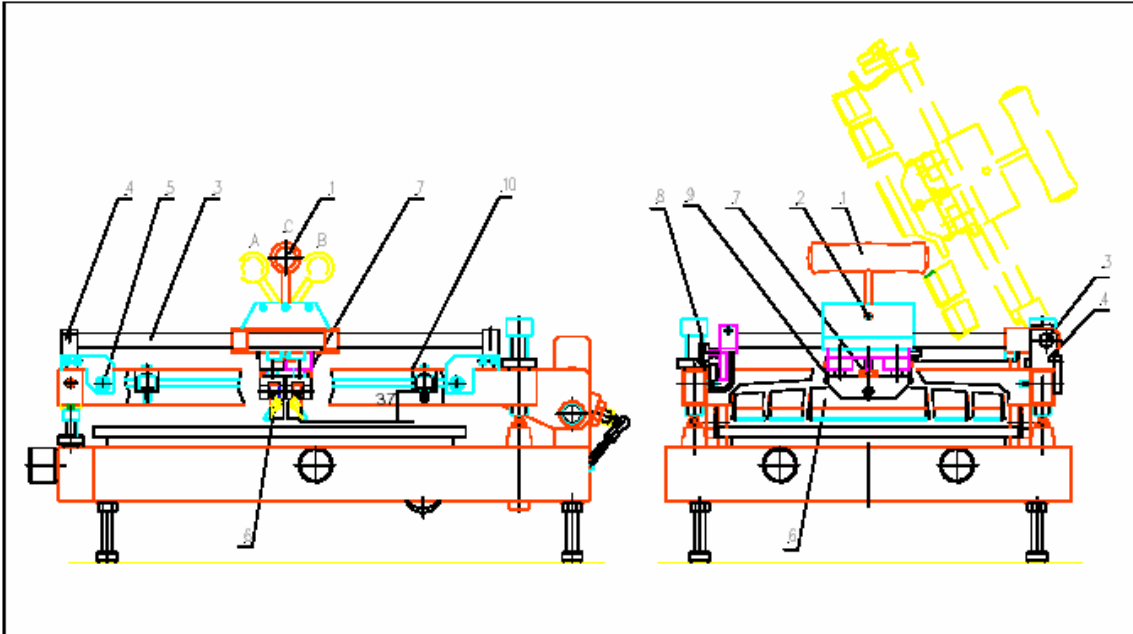
9.2. Printing speed

The squeegee speed must provide a slow rolling of the solder cream in front of the squeegee rubber. If the speed is too fast not all holes will be filled with solder cream. The speed is depending the consistency of the used solder cream, which can vary upon age, temperature and supplier.

9.3. Choosing the proper squeegee

The length of squeegee has to be equal, or at least not much longer, than the width of the printed substrate. If not so, the squeegee blade tends to bend on the PCB and the cleaning of the stencil surface from the paste cannot be uniform (thus resulting in non-uniform layer).

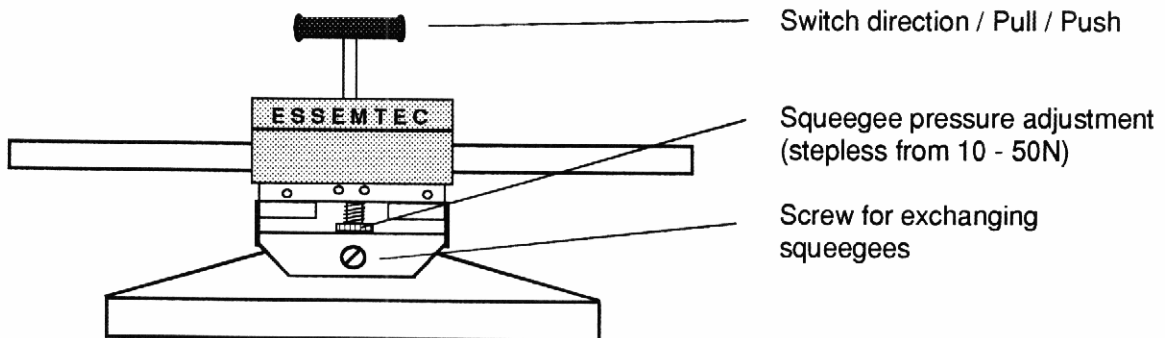
10. Printing with squeegee guidance (Option SP002-..R)



Printing with a squeegee guidance is offering the advantage to work user independent as squeegee pressure and angle are provided mechanically by the machine. Only the speed can be varied by the operator. The results are more repetitive and better printing results.

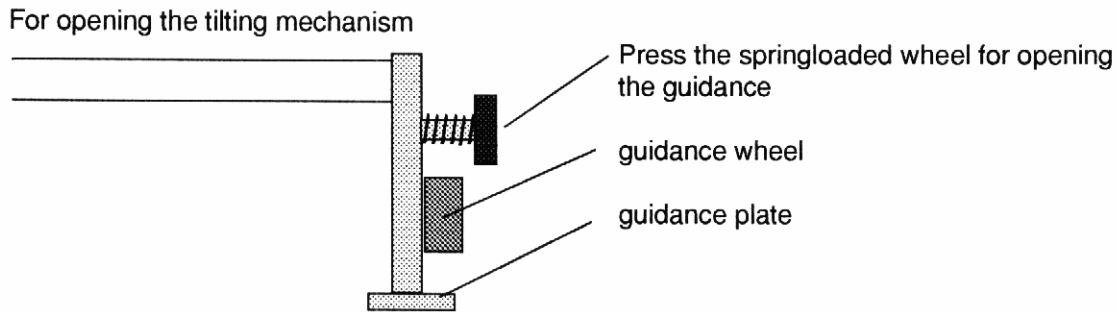
Additionally the squeegee guidance is equipped with a double squeegee which allows to print back and forth without applying new soldercream. It enhances therefore the printing speed and ensures that the SP002 can even be used beside fully automatic pick-and place systems for midsize production runs.

If desired with the separate adjustable squeegee pressure floating/printing jobs can be done easily (i.e. the holes are filed in one direction with a floating pressure and are then printed onto the PCB board in a second strike with more pressure)



frame so the squeegee guidance can not move.

For cleaning the squeegee, the complete squeegee guidance can be simply tilted out on one side (depending the side the guidance was mounted)



10.1. Assembly instruction for retrofit option SP002-....R

If retrofitted, You get following parts:

- Squeegee mechanisms head with lateral rods and brake
- guiding rod 3 with holders 4
- control handle 1
- pair of screws for mounting of the holders of of guiding rod 5
- pair of wqueegees with trailing edge of chosen length (130, 220 or 300 mm) 6

Assembly instruction

1. remove one guiding rod holder 4 (loosing screw and pulling the holder from the rod 3)
2. slide the head with lateral rods and brake onto the guiding rod. Be careful on the proper sense of head-to guiding orientation. The guiding squeegee set is fully symmetrical and You can obtain a configuration with guide on right side, or left side of the machine. Thus You can make the machine ergonomically for both right – and left- hander.
3. put the previously removed guide holder 4 back on the guiding rod 3. Do not fix it yet.
4. pull out two of rubber linders (most front and most rear) on that side of the upper frame on which You want to mount the gliding rod
5. remove both M5 screws under the rubber plugs
6. mount the guided squeegee assembly by means of two special screws 5. Before final fixing is important to check if the motion of guided squeegee is parallel with table surface and adjust if if necessary.
7. close the guided squeegee assembly – the opposite side to the guiding rod 3 is guided with both rollers form upper side and gliding spots from lower side of the rectangular guide rod. To achieve this, pull the black knob 8 and move the whole head down so that the both rollers touch the rectangular rod.
8. for mounting, celaning and exchange of squeegees pull the knob 8 and tilt the head with lateral rods to the required position (there is an optional support of opened squeegee assembly available)

10.2. Adjustment of print head height:

Resulting of occasion using different type of printing border and fashion their fastening. before adjustment it has to be upper frame of screen printer to the upper frame of screen printer to the right position against DPS or printing subject and both squeegees set on and adjust in the height position. For adjusting of height head is in the accessories of screen printer plastic plate diameter 4 mm.

- Loose 4 screws M3 holding dampers on the external corners of slide blocks printing head.
- Printing table lif to height position – it is only in model uniprit – lift
- Setting plastic diameter underlay under both squeegee in their middle so that sreen printer with printing table S, V and G, you put it on the face of table, concept M constitute it on placing backing plate, like foundation DPS.
- Squeegee, rubber or metal, put bottom edge on setting board. Be carreful!
- Damper in the corners of slide blocks gradually lift when the botton indoor edge of bottom flute touch peg. In this position you habe to fasten down screws M3.

10.3. Adustment of printing force

Each squeegee has its own mechanism for adjustment. The force can be adjustet with ribbed nut on each side of squeegee head. When proper adjusted, squeegee has to clean the surface of the metal micomask fully, but not to scrape-out the solder cream form apertures of mask. Squeegee is balanced, no other adjustment is necessary.

10.4. Adjustment of braking force

A squeegee head has a brake on the front/rear gliding, which stops and locks the position of head just after the operator's hand let it stay in any position. The braking force must be enough to keep the head in its position even when frame is opened. Proper adjustment is done at manufacturer, if the readjustment after some time will be needed, check for the proper function of breaking rubber stone and loose, or tight the nut of its rod proprietary.

10.5. Maintenance of guided squeegee

The guided squeegee is virtually maintenance-free. All bearings and gliding are self-lubricated/Teflon lined.

Do not lubricate giding rod 3! – the brake will than loose its efficiency. Keep the mechnism clean and prevent any spillage with solder cream. If dirty, clean smoothly with alcohol or isopropanol.

Do not work on dry stncil, or screen (i.e. without solder cream or glue on it) – the friction forces are too high, you risk a serious damage of your masks. All bearings of guided squeegee assembly are exposed to higher forces, which speeds up their wearing.

11. Hints and tips for screen / stencilprinting

11.1. Soldercream

Here some advices out of practice to help you achieving good printing results:

- Use only soldercream which is intended to be used on screen/stencilprinters
- store soldercream below 25°C, to store the solder cream the longest possible period it is recommended to store it between 8° and 10°C.
- Before using the soldercream bring it to room temperature and open the can only when room temperature is reached.
- Soldercream you already used within the printer must not be put back into the can/glas
- the smallest opening on your stencil, resp. the smallest mesh should be not under the 7times size of the solder ball. For Fine-Pitch applications special solder cream is available with smaller solder balls. Ask your solder cream supplier for further in formations
- Apply a sufficient amount of soldercream onto the screen/stencil to ensure proper rolling and printing quantity

11.2. Some tips for good result with solder paste printing

1. **Printig Gap** good value is 0,005 x printing stroke length
2. **The Squeegee** we provide 75hsH for manual squeegee(yellow) and 85hsH for guided squeegee(white). The harder is suitable for metal micro-etched masks, the softer for emulsion masks.
3. **he Printing Pressure** on the guided squeegee can be set step-less from 10N to 50N. You can see a good adjusted pressure directly on the mask – it has to be cleaned fully from the solder paste, but the solder paste must not be wiped-out from bigger openings in the mask.
4. **The Squeegee/Table Print Angle**
 basic setting during action is 60°. The bigger angle does not allow the solder paste to come through the mask fully, the smaller makes a too big pressure of the paste and causes dirty screen from lower side, thus not correct printing.
5. **The Squeegee Speed** depends on paste rheology. Paste should always be rolling in front of the squeegee. Too high speed makes print uncompleted.
6. Keep the lower face of the screen always clean.
7. The smallest opening in the mask (or screen mesh) should be not smaller, than 7diameters of the solder paste ball.
8. Never open the solder cream jar before coming to the room temperature.
9. Never mix the new and used solder cream in the same jar.

12. Vertical Separation (Option)

This modification is equipped by pneumatic lifting of screen printer table controlled by hand valve placed in the front between knobs.

The lifting of screen printer table is 3mm The print is always made in the upper position and by letting down of the table is smudge of the printing motive by stencil prevented. Other procedures are the same as for Uniprint.

There is needful supply of the compressed air mas. t bar, the pressure is controllable by regulation valve – placed form behind the screen printer.

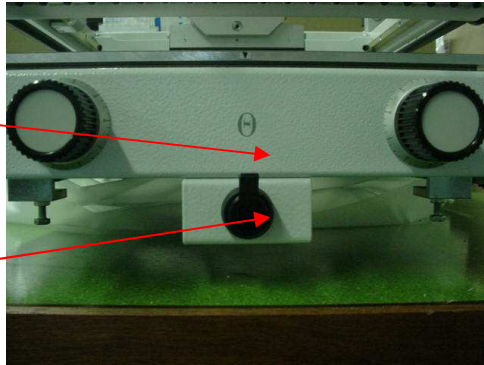
The speed of lifing of the table is to set by the fhrottle valve on the output of the regulator. The speed of letting down is to set by the throttle valve placed in the front right corner of the bottom frame.

Important: The overly throttled valve of the compressed air causes uneven letting down or lifting of the table. Setting of appropriate speed of the table is recommended.

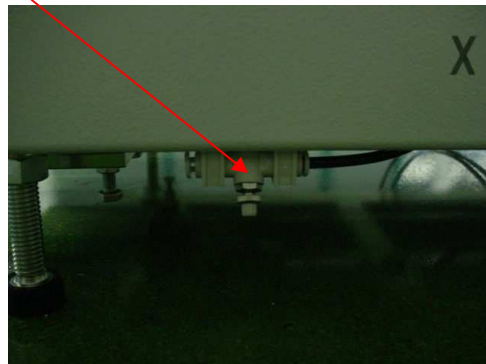
Maintenance: no special maintenance required.

Function is as follows:

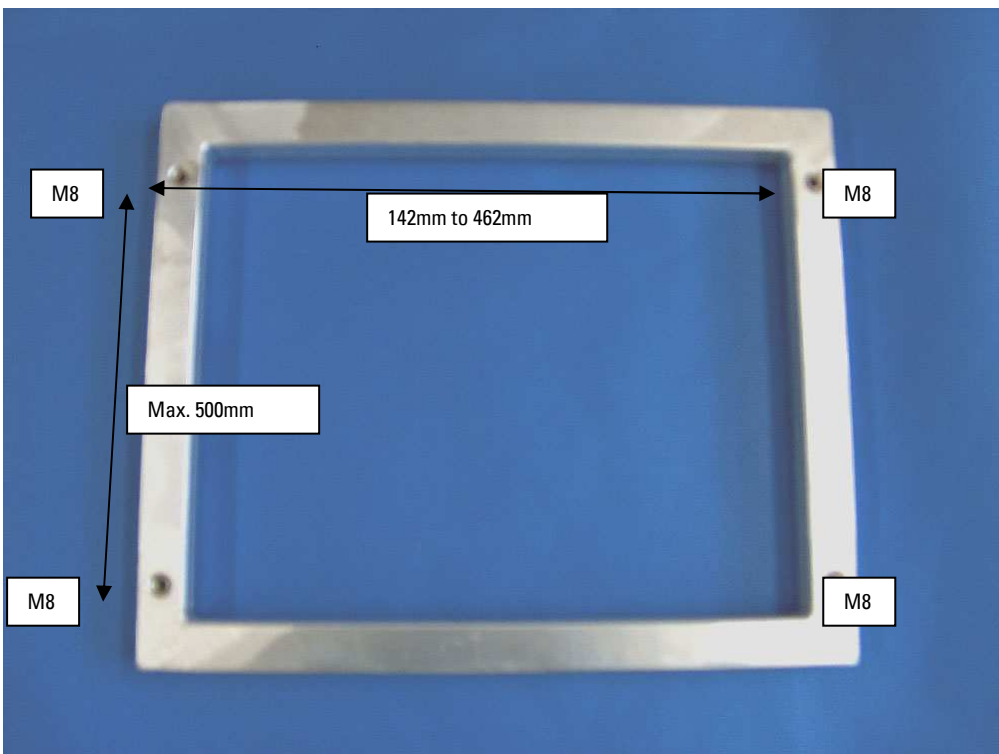
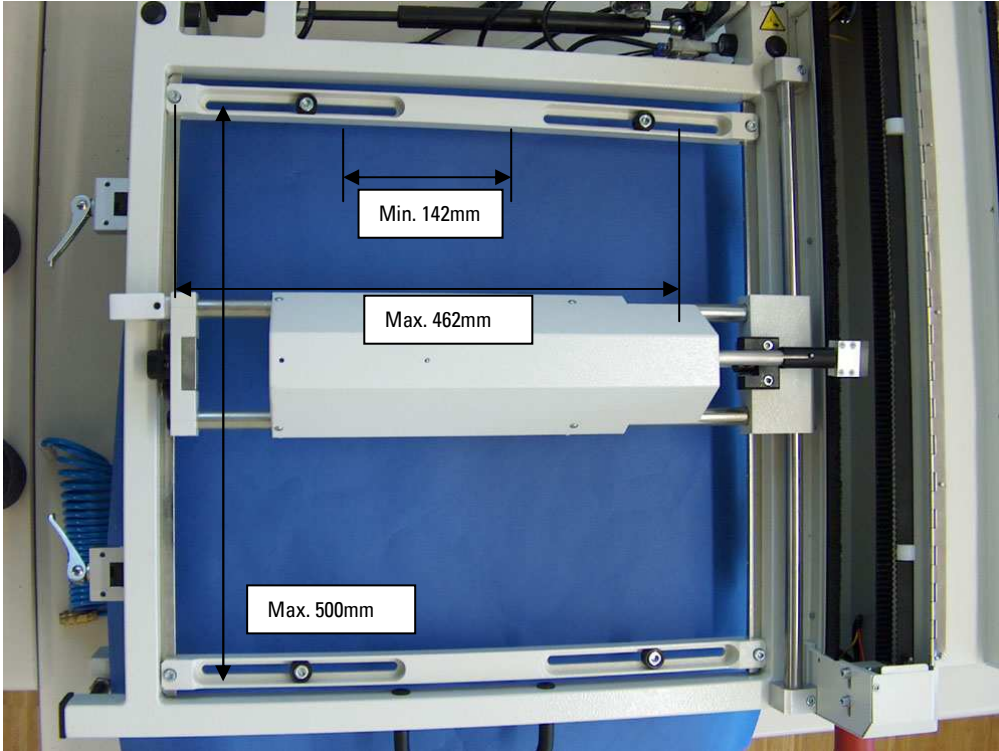
1. Insert a PCB
2. Bring the printing table in its upward position
3. Lower the stencil onto the board
4. Print
5. Bring the printing table in its lower position (= vertical separation)
6. Open the upper frame and take out the PCB



The separation speed can be additionally adjusted by a valve on the right side of the printer.



13. Schablonenbeschreibung SPGEN-12 Spannrahmen



14. Maintenance advice

Practically all guidances are dry guided and must therefore not be maintained. Prevent soldercream on the guidances and keep your machine always clean.

Only the guidance of the x/y-baseplate must be greased once per year with high quality grease.

CE-DECLARATION OF CONFORMITY

Machine SR: 98/37/CE

Manufacturer **ESSEMTEC AG**

Adress of Manufacturer ESSEMTEC AG
Mosenstrasse 20
CH – 6287 Aesch LU
Switzerland

We herewith declare, that the mentioned machines are in conformity with the above stated standards and healthy and safety rules of the CE directives.
If there are any changes on the machine as also on their options by the user/customer, this declaration will expire immediately.

Typ: Screen- and Stencilprinter

SP002-M / ML
SP002-G / GL
SP002-V / VL
SP002-B / BL

Accessories: all

Serial number: _____

Date of manufacture: _____

Applied/used harmonised
european norms:

EN60204-1, EN292-1, EN292-2, EN1050, EN894-3,
EN294, EN62079, EN953, EN983

ESSEMTEC AG



Martin A. Ziehbrunner
Director

Aesch, _____